

Medium Power Transistor (-80V, -0.7A)

2SB1189 / 2SB1238 / 2SB889F

●Features

- 1) High breakdown voltage, $V_{CEO} = -80V$, and high current, -0.7A.
- 2) Complements the 2SD1767 / 2SD1859 / 2SD1200F.

●Packaging specifications and hFE

Type	2SB1189	2SB1238	2SB889F
Package	MPT3	ATV	TO-126FP
hFE	PQR	PQR	Q
Marking	BD*	—	—
Code	T100	TV2	—
Basic ordering unit (pieces)	1000	2500	1000

* Denotes hFE

●Electrical characteristics ($T_a=25^\circ C$)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	V_{CBO}	-80	—	—	V	$I_c = -50 \mu A$
Collector-emitter breakdown voltage	V_{CEO}	-80	—	—	V	$I_c = -2mA$
Emitter-base breakdown voltage	V_{EBO}	-5	—	—	V	$I_e = -50 \mu A$
Collector cutoff current	I_{CBO}	—	—	-0.5	μA	$V_{CB} = -50V$
Emitter cutoff current	I_{EBO}	—	—	-0.5	μA	$V_{EB} = -4V$
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	-0.2	-0.4	V	$I_c/I_e = -500mA/-50mA$
DC current transfer ratio	hFE	82	—	390	—	$V_{CE}/I_c = -3V/-0.1A$
2SB1189, 2SB186A 2SB889F		120	—	270	—	
Transition frequency	f_T	—	100	—	MHz	$V_{CE} = -10V, I_e = 50mA, f = 100MHz$
Output capacitance	C_{OB}	—	14	20	pF	$V_{CB} = -10V, I_e = 0A, f = 1MHz$

●Absolute maximum ratings ($T_a=25^\circ C$)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V_{CBO}	-80	V
Collector-emitter voltage	V_{CEO}	-80	V
Emitter-base voltage	V_{EBO}	-5	V
Collector current	I_c	-0.7	A
		0.5	
Collector power dissipation	P_c	2	W *1
		1	*2
		5	W ($T_c = 25^\circ C$)
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

*1 When mounted on a 40×40×0.7mm ceramic board.

*2 Printed circuit board 1.7mm thick, collector plating 1cm² or larger.

(96-618-B13)

Medium Power Transistor (80V, 0.7A)

2SD1767 / 2SD1859 / 2SD1200F

●Features

- 1) High breakdown voltage, $V_{CEO} = 80V$, and high current, 0.7A.
- 2) Complements the 2SB1189 / 2SB1238 / 2SB889F.

●Packaging specifications and hFE

Type	2SD1767	2SD1859	2SD1200F
Package	MPT3	ATV	TO-126FP
hFE	PQR	QR	QR
Marking	DC*	—	—
Code	T100	TV2	—
Basic ordering unit (pieces)	1000	2500	1000

* Denotes hFE

●Absolute maximum ratings ($T_a=25^\circ C$)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V_{CBO}	80	V
Collector-emitter voltage	V_{CEO}	80	V
Emitter-base voltage	V_{EBO}	5	V
Collector current	I_c	0.7	A (DC)
		1	A (Pulse) *1
Collector power dissipation	P_c	0.5	
		2	W *2
		1	*3
		5	W ($T_c = 25^\circ C$)
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

*1 $P_w = 10ms$, duty = 1/2

*2 When mounted on a 40×40×0.7mm ceramic board.

*3 Printed circuit board 1.7mm thick, collector plating 1cm² or larger.

●Electrical characteristics ($T_a=25^\circ C$)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	V_{CBO}	80	—	—	V	$I_c = 50 \mu A$
Collector-emitter breakdown voltage	V_{CEO}	80	—	—	V	$I_c = 2mA$
Emitter-base breakdown voltage	V_{EBO}	5	—	—	V	$I_e = 50 \mu A$
Collector cutoff current	I_{CBO}	—	—	0.5	μA	$V_{CB} = 50V$
Emitter cutoff current	I_{EBO}	—	—	0.5	μA	$V_{EB} = 4V$
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	0.2	0.4	V	$I_c/I_e = 500mA/50mA$
DC current transfer ratio	hFE	82	—	390	—	$V_{CE}/I_c = 3V/0.1A$
2SD1767 2SD1859, 2SD1200F		120	—	390	—	
Transition frequency	f_T	—	120	—	MHz	$V_{CE} = 10V, I_e = -50mA, f = 100MHz$
Output capacitance	C_{OB}	—	10	—	pF	$V_{CB} = 10V, I_e = 0A, f = 1MHz$

(96-750-D13)